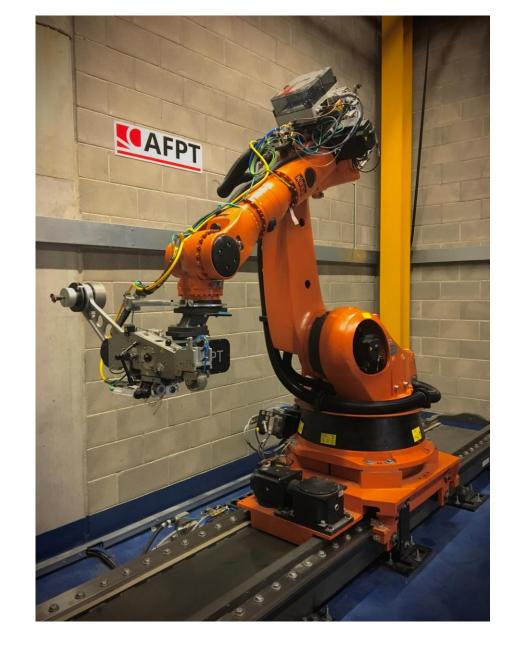


The Influence of Processing Parameters on Tape Deconsolidation in Thermoplastic Composites

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Introduction and Question

- There is increasing interest in Laser-assisted Automated Tape Placement (LATP) as a fibre-reinforced thermoplastic composite structure manufacturing method
- Compared to other systems it offers low waste, low energy usage, high repeatability and reduced labour cost [1] However, the process is not yet widely adopted in industry due to:



- **Poorer component quality** compared to conventional consolidation methods (autoclave and hot-press)
- Issues surrounding **bond quality, voids and tape deconsolidation** [2]

Tape deconsolidation is a change of mesostructure of the tape during processing

Can optimised process parameters improve bond quality, reduce void content and deconsolidation in thermoplastic composites?

Manufacturing combinations used – number is sample indicator

Methodology

- **Hoop** samples with various processing parameter combinations manufactured
- Performance assessed by Interlaminate Shear Strength (ILSS) tests conducted in accordance with ASTM D-2344

Indicated Temperature* (°C)	Placement Rate (m/min)		
	3	9	15
400	1	4	7
450	2	5	8
500	3	6	9

* IR Camera indicated nip-point temperature – the actual temperature may be lower

Results

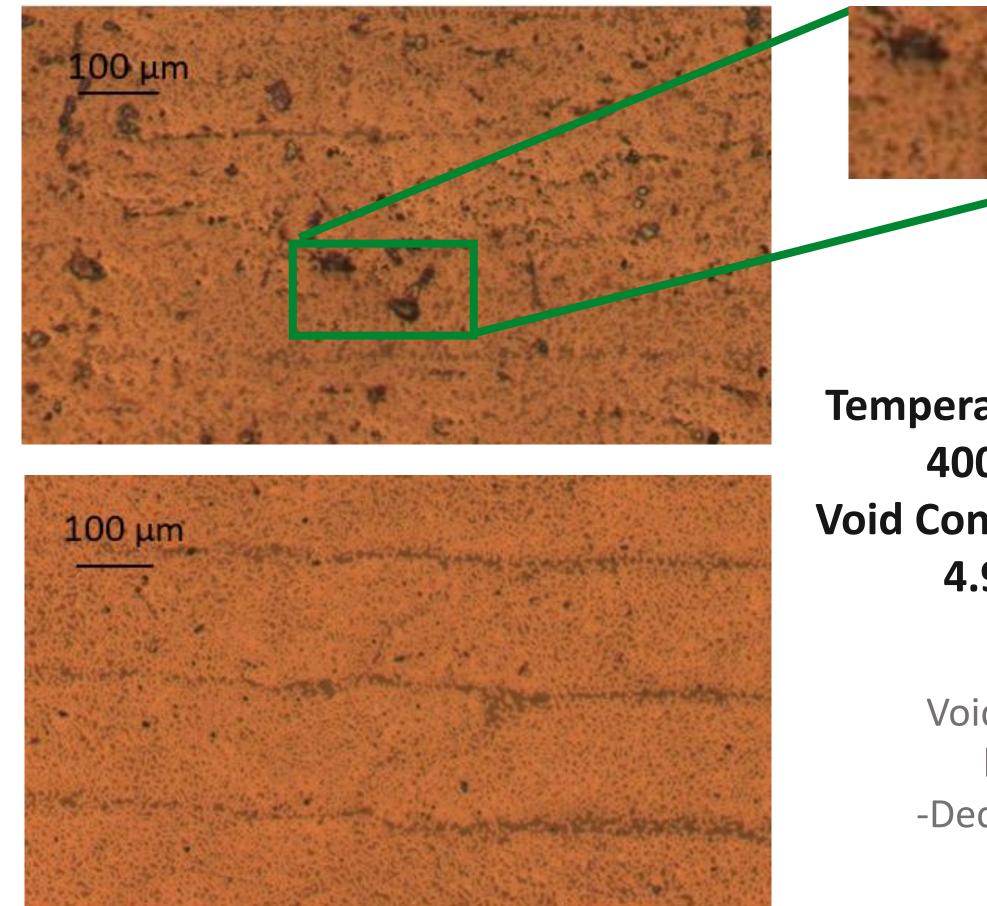
- Sample thickness increased as a result of processing
- Increasing placement rate at constant temperature reduced sample thickness
- No direct correlation between constant placement rate and increasing

Above 400°C crystallinity had low variation, regardless of placement rate

28% - 32%

temperature

Thickness change as a result of deconsolidation

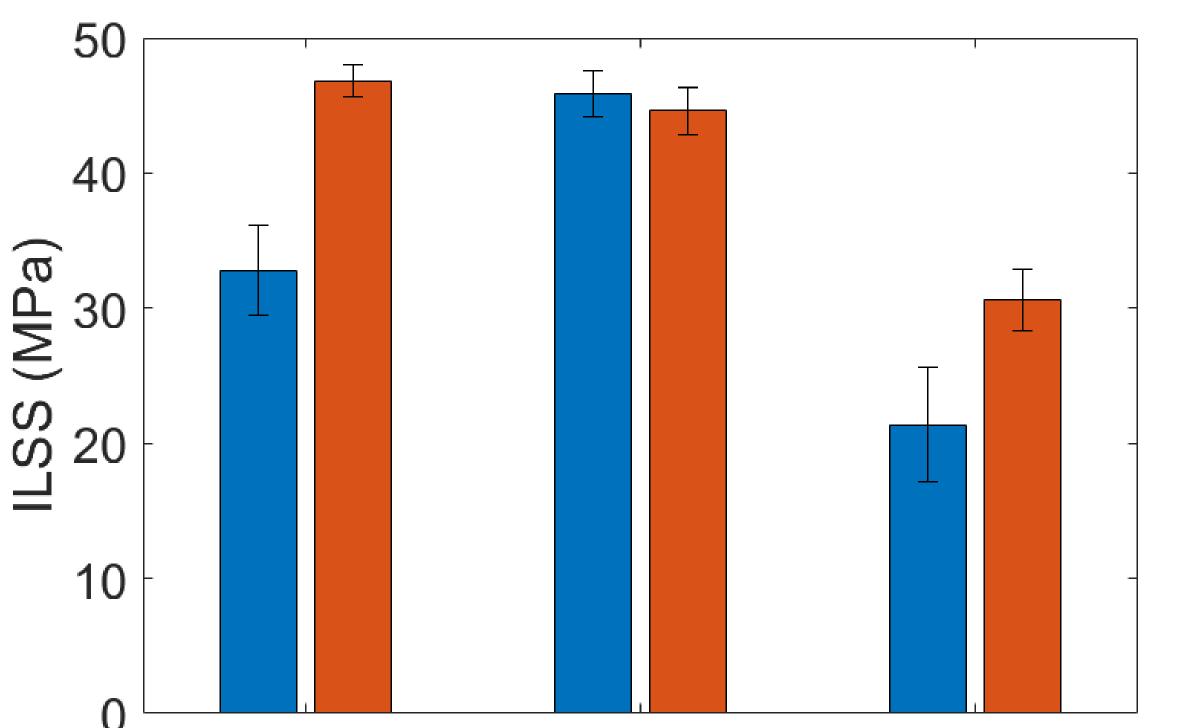


Temperature Increasing: 400°C - 500 °C **Void Content Decreasing:** 4.9% - 0.65%

> Void not at tape bond line -Deconsolidation

Poor bonding at 400 °C indicated temperature resulted in no ILSS data above 3 m/min placement rate





15 m/min 3 m/min 9 m/min

Conclusion

- Voids developed within the tape as a result of deconsolidation
- Increasing placement rate with constant temperature reduced ILSS
- Increasing temperature with increasing placement rate increases ILSS
- Correlation observed between higher void content and lower ILSS

References

(MPa)

[1] Comer AJ, Ray D, Obande WO, Jones D, Lyons J, Rosca I, et al. Mechanical characterisation of carbon fibre–PEEK manufactured by laser-assisted automatedtape-placement and autoclave. Composites Part A: Applied Science and Manufacturing. 2015;69:10-20.

[2] Grouve WJB, Warnet L, Akkerman R, Wijskamp S, Kok JSM. Weld Strength Assessment for Tape Placement. International Journal of Material Forming. 2010;3(S1):707-10.

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